

Wicks easily into tight spaces

5051 is an optically clear, low viscosity, electrically isolating epoxy compound. It bonds well to most substrates such as metals, glass, ceramics, and most plastics. The material is free flowing, making it ideal for potting and underfill applications.

UNCURED	
Work Life @ 25°C	8 hours
Mixed Viscosity @ 25°C	320 cPs
Pot Life @ 25°C	4 hours
Shelf Life	12 months @ 25°C (2-part Kits) 12 months @ -40°C (Cryo-Pac®)
Mix Ratio	100A : 34.5B Parts By Weight
CURE OPTIONS	6 hours @ 80°C 8 hours @ 65°C 8 days @ 25°C
CURED PROPERTIES	Based on cure of 6 hours @ 80°C
Color	Clear
Shore D Hardness	83
Glass Transition Temp (°C)	85
Lap Shear 2024T3 Clad (psi)	3,300
Density (g/cc)	1.15
Refractive Index	1.56
Shrinkage Linear (%)	0.2
ELECTRICAL PROPERTIES	Based on cure of 6 hours @ 80°C
Dielectric Constant	3.013 @ 60 Hz 3.052 @ 1k Hz 2.846 @ 100k Hz
Dissipation Factor	0.0061 @ 60 Hz 0.0118 @ 1k Hz 0.0382 @ 100k Hz
Volume Resistivity (ohm-cm)	1.7E 16 @ 500 VDC
THERMAL PROPERTIES	Based on cure of 6 hours @ 80°C
Glass Transition Temp (°C)	85
Degradation Temp. (°C)	250

KEY FEATURES

Bonds Well to Most Substrates

Free Flowing

Wicks Easily Into Tight Spaces

Long Work Life

Low Viscosity

Optically Clear

User-friendly Packaging

Talk to an engineer:

service@appli-tec.com

603-685-0500 ext. 528

www.appli-tec.com

7 Industrial Way, Unit 1, Salem, NH 03079

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